SiDR626DP **Vishay Siliconix** 

www.vishay.com

N-Channel 60 V (D-S) MOSFET

# PowerPAK<sup>®</sup> SO-8DC G

Top View

Bottom View

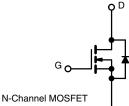
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0017				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 7.5 V	0.0020				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 6 V	0.0026				
Q <sub>g</sub> typ. (nC)	52				
I <sub>D</sub> (A) <sup>a, g</sup>	100				
Configuration	Single				

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- Very low R<sub>DS</sub> Q<sub>q</sub> figure-of-merit (FOM)
- Tuned for the lowest R<sub>DS</sub> Q<sub>oss</sub> FOM
- 100 % R<sub>q</sub> and UIS tested
- Top side cooling feature provides additional venue for thermal transfer
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### APPLICATIONS

- Synchronous rectification
- Primary side switch
- DC/DC converter
- · Solar micro inverter
- Motor drive switch
- · Battery and load switch
- Industrial



ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR626DP-T1-GE3

PARAMETER Drain-source voltage		SYMBOL	LIMIT	UNIT	
		V <sub>DS</sub>	60	V	
Gate-source voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		100 <sup>a</sup>		
Operation of the intervent (T 150 %O)	T <sub>C</sub> = 70 °C	1 . [	100 <sup>a</sup>		
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C		42.8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1 [	34.2 <sup>b, c</sup>	Α	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	200		
	T <sub>C</sub> = 25 °C		100 <sup>a</sup>		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	5.6 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	50		
Single pulse avalanche energy		E <sub>AS</sub>	125	mJ	
	T <sub>C</sub> = 25 °C		125		
Maximum neuror dissinction	T <sub>C</sub> = 70 °C		80	w	
Maximum power dissipation	T <sub>A</sub> = 25 °C	PD	6.25 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1 [	4 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub> -55 to +150		<u></u>	
Soldering recommendations (peak temperature) <sup>c</sup>			260	-0	

#### THERMAL RESISTANCE RATINGS

THENMAL RESISTANCE RATH	103				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.8	1	°C/W
Maximum junction-to-case (source)	Steady state	R <sub>thJC</sub>	1.1	1.4	

Notes a. Package limited

b. Surface mounted on 1" x 1" FR4 board

t = 10 s See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8DC is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 54 °C/W  $T_{C} = 25$  °C d.

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f.

g.

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SiDR626DP

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					1	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	60	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	35	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-7.4	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	-	3.4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA
7		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	•
Zero gate voltage drain current	IDSS	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	15	μA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	40	-	-	А
	, , ,	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0014	0.0017	1
rain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 20 A	-	0.0016	0.0020	Ω
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 10 A	$\begin{array}{c c c c c c c c c }\hline & & & & & & & & & & & & & & & & & & &$			
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	78	-	S
Dynamic <sup>b</sup>					1	
Input capacitance	C <sub>iss</sub>		-	5130	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	992	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	94	-	
		$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	-	68	102	1
Total gate charge	Qg		-	52	78	nC
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 7.5 \text{ V}, I_{D} = 10 \text{ A}$	-	21	-	
Gate-drain charge	Q <sub>gd</sub>		-	8.2	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	68	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.3	0.91	1.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	16	32	
Rise time	tr	$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 3 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	24	48	-
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	30	60	
Fall time	t <sub>f</sub>		-	11	22	
Turn-on delay time	t <sub>d(on)</sub>		-	19	38	ns
Rise time	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, \text{ R}_{\text{L}} = 3 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$	-	25	50	-
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 7.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	27	54	
Fall time	t <sub>f</sub>		-	12	24	
Drain-Source Body Diode Characteristi	cs				1	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	100	
Pulse diode forward current	I <sub>SM</sub>	-	-	-	200	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.72	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	54	108	ns
Body diode reverse recovery charge	Q <sub>rr</sub>		-	64	128	nC
Reverse recovery fall time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	-	35	-	
Reverse recovery rise time	t <sub>b</sub>		-	29	-	ns

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

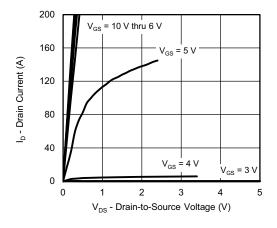
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

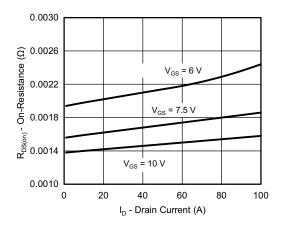
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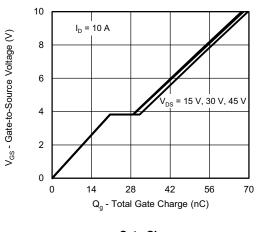
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



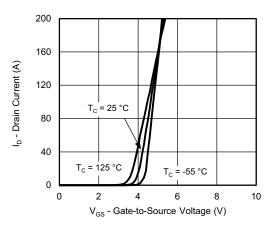
**Output Characteristics** 



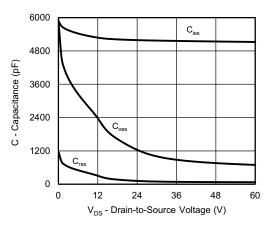
**On-Resistance vs. Drain Current and Gate Voltage** 



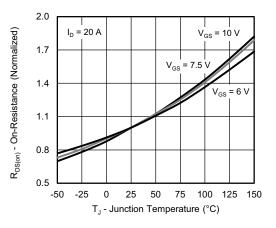
Gate Charge



**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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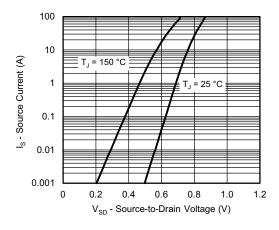
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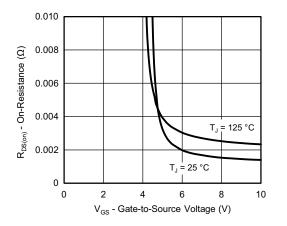
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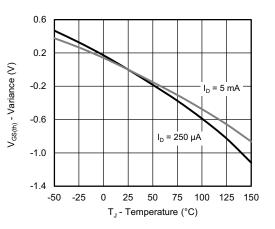
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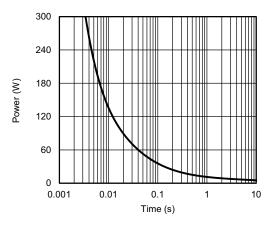
Source-Drain Diode Forward Voltage



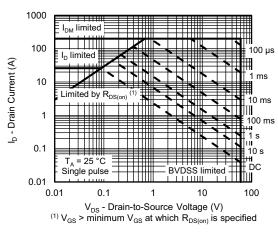
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

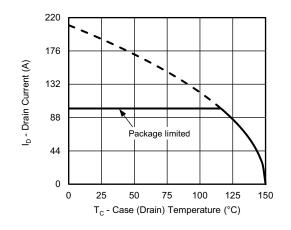
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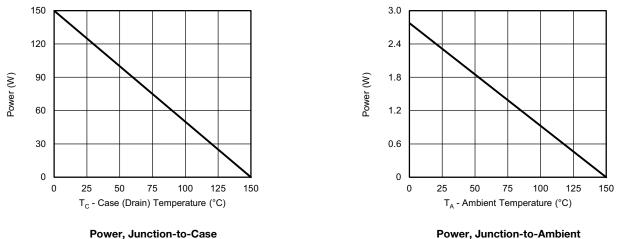
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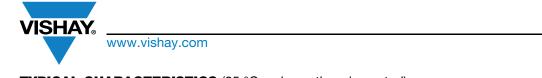
Current Derating <sup>a</sup>



Power, Junction-to-Ambient

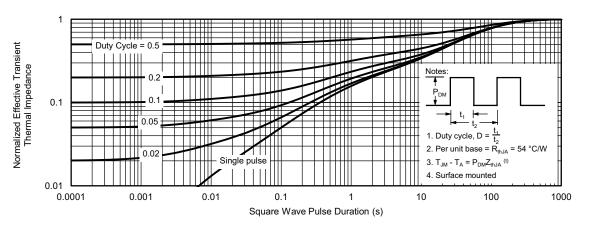
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

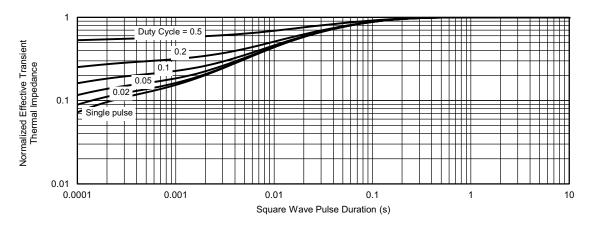




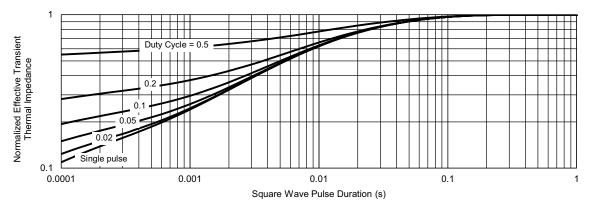
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient









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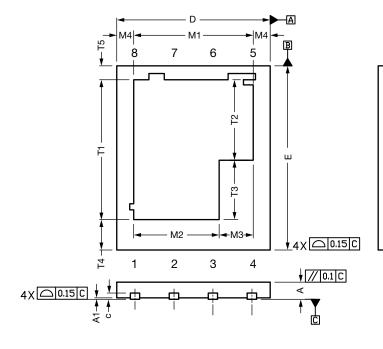
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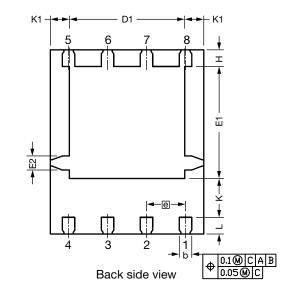
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## PowerPAK<sup>®</sup> SO-8 Double Cooling Case Outline

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	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.51	0.56	0.61	0.020	0.022	0.024	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
b	0.36	0.41	0.46	0.014	0.016	0.018	
С	0.15	0.20	0.25	0.006	0.008	0.010	
D	4.90	5.00	5.10	0.193	0.197	0.201	
D1	3.71	3.76	3.81	0.146	0.148	0.150	
е		1.27 BSC			0.050 BSC		
E	5.90	6.00	6.10	0.232	0.236	0.240	
E1	3.60	3.65	3.70	0.142	0.144	0.146	
E2	0.46 typ.			0.018 typ.			
Н	0.49	0.54	0.59	0.019	0.021	0.023	
К	1.22	1.27	1.32	0.048	0.050	0.052	
K1		0.64 typ.		0.025 typ.			
L	0.49	0.54	0.59	0.019	0.021	0.023	
M1	3.85	3.90	3.95	0.152	0.154	0.156	
M2	2.74	2.79	2.84	0.108	0.110	0.112	
M3	1.06	1.11	1.16	0.042	0.044	0.046	
M4		0.56 typ.		0.022 typ.			
Ν		8		8			
T1	4.51	4.56	4.61	0.178	0.180	0.182	
T2	2.58	2.63	2.68	0.102	0.104	0.106	
Т3	1.88	1.93	1.98	0.074	0.076	0.078	
T4	0.97 typ.			0.038 typ.			
T5	0.48 typ.				0.019 typ.		
√: T21-0014-Re	v. B, 08-Feb-2021						

Revison: 08-Feb-2021

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# Application Note 826

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#### RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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